




- A1–A2, A6** West Entrance EMS Electronic manufacturing services, PCBs and other circuit carriers
- A3 B2–B3** Electromechanics and system peripherals, Interconnection components
- B3** Electromechanics and system peripherals, Interconnection components, Casing technology
- A4** Test and measurement
- A5** Power supplies
- A6/B6** Passive components
- B4** Sensor and driving technology, Microsystems and MEMS
- B4** all halls Automotive
- B5 C2–C6** all halls Embedded Computing
- B5 C2–C6** Semiconductors
- B6** Displays
- C2** Wireless
- B0–B1 C1–C2** SEMICON Europa 2026 
- all halls** ED/EDA / Services
- ICM** Conferences

Planning status as of: 4/2026 (Subject to change)

- Forums**
- A1: PCB, EMS & Components Marketplace**
 - PCB, EMS & Components
 - Printed Electronics by LOPEC & OE-A
 - A5: electronica Stage**
 - Electrical Connectors
 - Measurement Technology
 - Obsolescence
 - B4: Start-up Stage**
 - electronica Fast Forward
 - B4: Smart Mobility Stage**
 - Automotive
 - Printed Electronics by LOPEC & OE-A
 - C6: Future Tech Stage**
 - Cyber Security
 - Embedded Developer
 - IIoT
 - Women in Tech
 - C6: Semiconductor Innovation Stage**
 - Chiplets
 - Embedded Systems
 - Power Electronics
 - SEMICON Europa Stages**
 - Executive Forum (C1)
 - TechARENA (B0)